

Features

- Trench LV MOSFET Technology
- Moisture Sensitivity Level 1
- Halogen Free. "Green" Device^(Note1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

Maximum Ratings

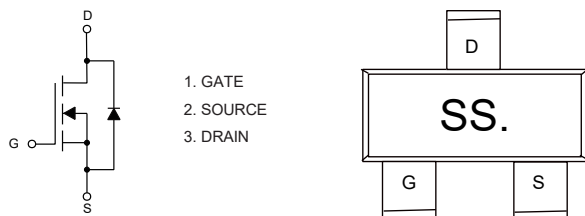
- Operating Junction Temperature Range: -55°C to +150°C
- Storage Temperature: -55°C to +150°C
- Thermal Resistance: 395°C/W Junction to Ambient^(Note2)

Parameter		Symbol	Rating	Unit
Drain-Source Voltage		V _{DS}	50	V
Gate-Source Voltage		V _{GS}	±20	V
Continuous Drain Current	T _A =25°C	I _D	0.22	A
	T _A =100°C		0.14	
Pulsed Drain Current ^(Note3)		I _{DM}	0.88	A
Total Power Dissipation ^(Note4)		P _D	316	mW

Note:

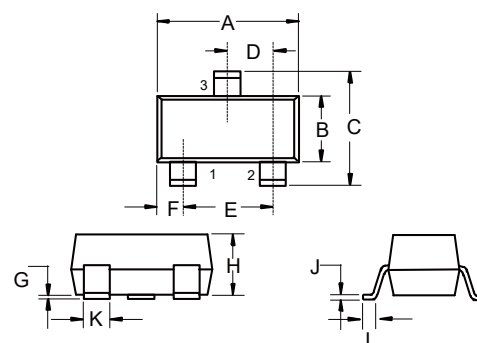
1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^{\circ}\text{C}$.
3. Repetitive rating; pulse width limited by max. junction temperature.
4. P_D is based on max. junction temperature, using junction-ambient thermal resistance.

Internal Structure and Marking code



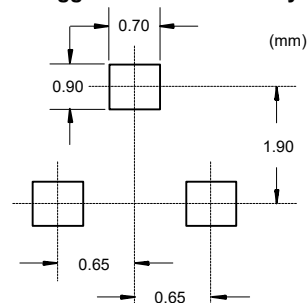
N-Channel MOSFET

SOT-323



DIMENSIONS					
DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.071	0.087	1.80	2.20	
B	0.045	0.053	1.15	1.35	
C	0.083	0.096	2.10	2.45	
D	0.026		0.65		TYP.
E	0.047	0.055	1.20	1.40	
F	0.012	0.016	0.30	0.40	
G	0.000	0.004	0.00	0.10	
H	0.035	0.044	0.90	1.10	
J	0.002	0.010	0.05	0.25	
K	0.006	0.016	0.15	0.40	
L	0.010	0.018	0.26	0.46	

Suggested Solder Pad Layout



Electrical Characteristics @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250μA	50			V
Gate-Source Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =50V, V _{GS} =0V			0.5	μA
		V _{DS} =50V, V _{GS} =0V, T _J =125℃			5	
		V _{DS} =30V, V _{GS} =0V			0.1	
Gate-Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =1mA	0.8	1	1.5	V
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =10V, I _D =0.22A		1.2	3.5	Ω
		V _{GS} =4.5V, I _D =0.22A		1.3	6	
Forward Transconductance	g _{FS}	V _{DS} =5V, I _D =0.22A		650		mS
Gate Resistance	R _G	f=1 MHz, Open drain		5		Ω
Diode Characteristics						
Continuous Body Diode Current	I _S				0.22	A
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =0.22A			1.2	V
Reverse Recovery Time	t _{rr}	I _F =0.22A, dI _F /dt=100A/μs		10		ns
Reverse Recovery Charge	Q _{rr}			2.4		nC
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{DS} =25V,V _{GS} =0V,f=1MHz		29		pF
Output Capacitance	C _{oss}			3.2		
Reverse Transfer Capacitance	C _{rss}			2		
Total Gate Charge	Q _g	V _{DS} =25V,V _{GS} =10V,I _D =0.22A		1.3		nC
Gate-Source Charge	Q _{gs}			0.14		
Gate-Drain Charge	Q _{gd}			0.25		
Turn-On Delay Time	t _{d(on)}	V _{DS} =30V, V _{GS} =10V, R _G =6Ω, I _D =0.29A		2		ns
Turn-On Rise Time	t _r			3		
Turn-Off Delay Time	t _{d(off)}			5		
Turn-Off Fall Time	t _f			13		

Curve Characteristics

Fig.1 - Typical Output Characteristics

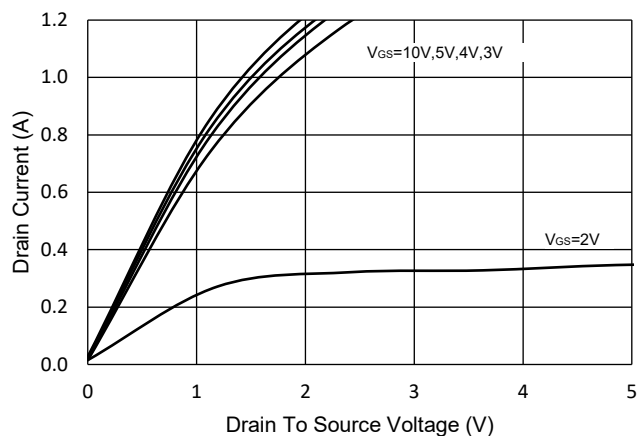


Fig.2 - Transfer Characteristic

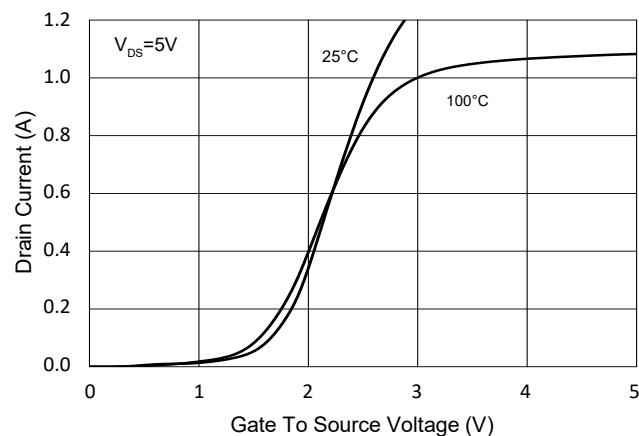


Fig.3 - $R_{DS(ON)}$ - V_{GS}

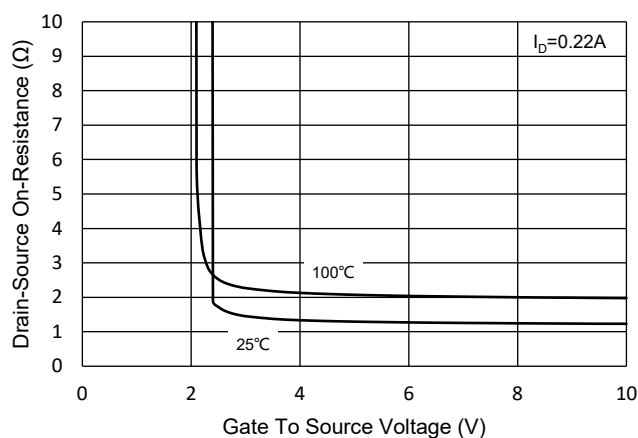


Fig.4 - $R_{DS(ON)}$ - I_D

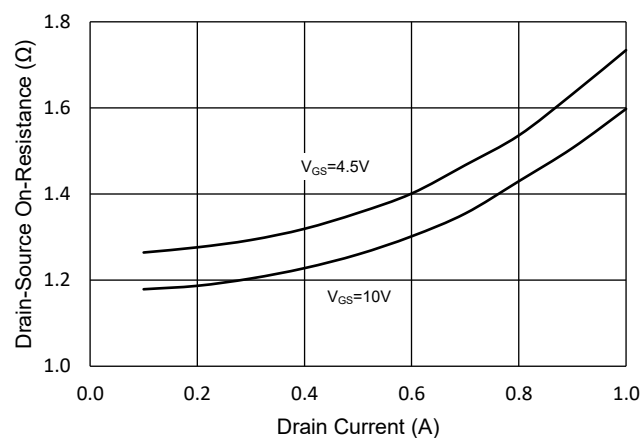


Fig.5 - Capacitance Characteristics

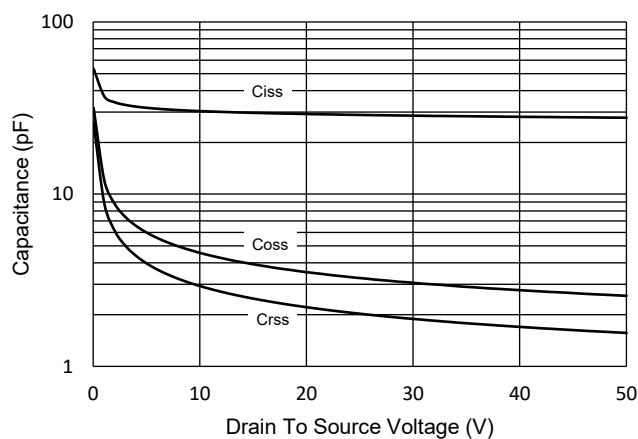
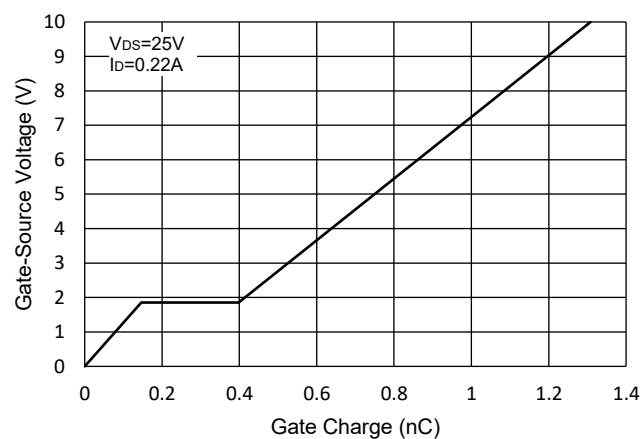


Fig.6 - Gate Charge



Curve Characteristics

Fig.7 - Normalized Threshold Voltage

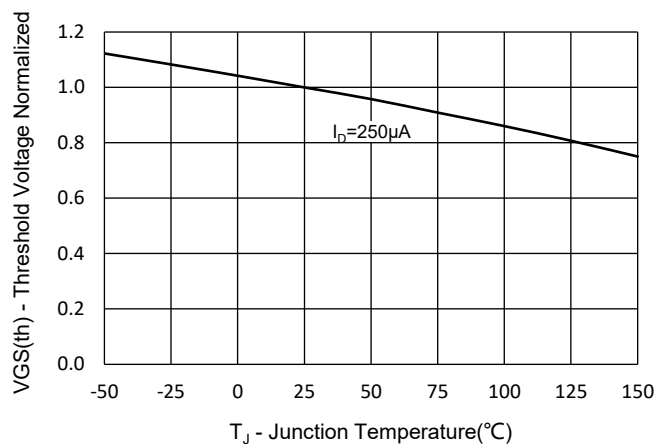


Fig.8 - Normalized On Resistance Characteristics

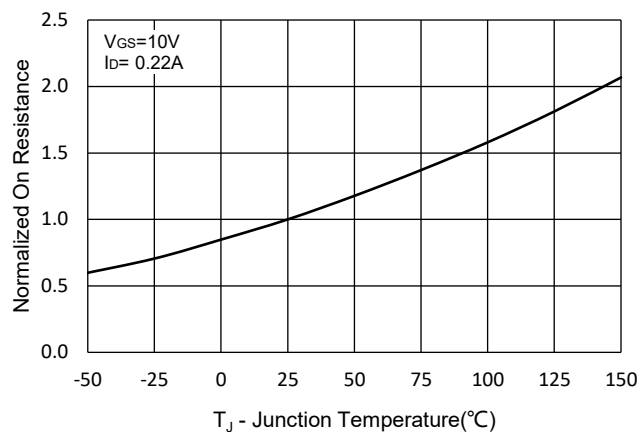


Fig.9 - $I_S - V_{SD}$

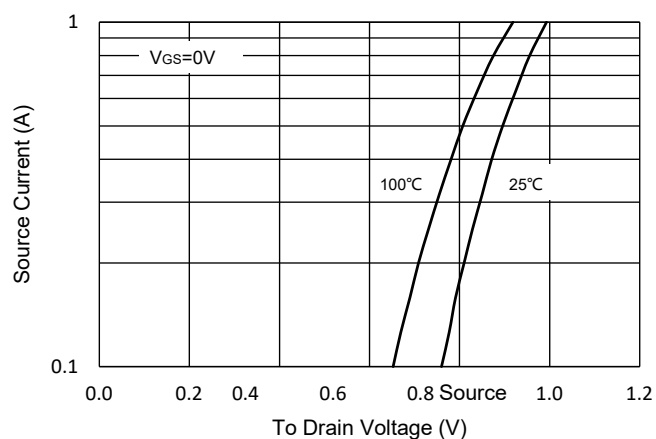


Fig.10 - Drain Current

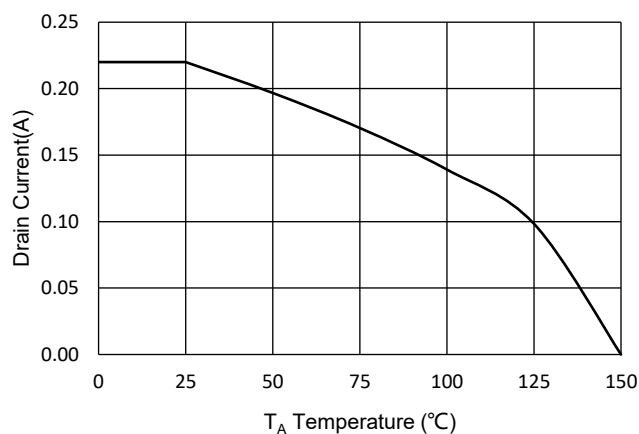
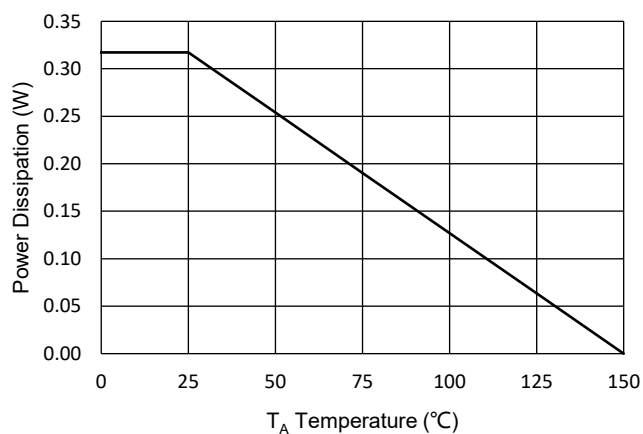


Fig.11 - PD Dissipation



Curve Characteristics

Fig.12 - Safe Operation Area

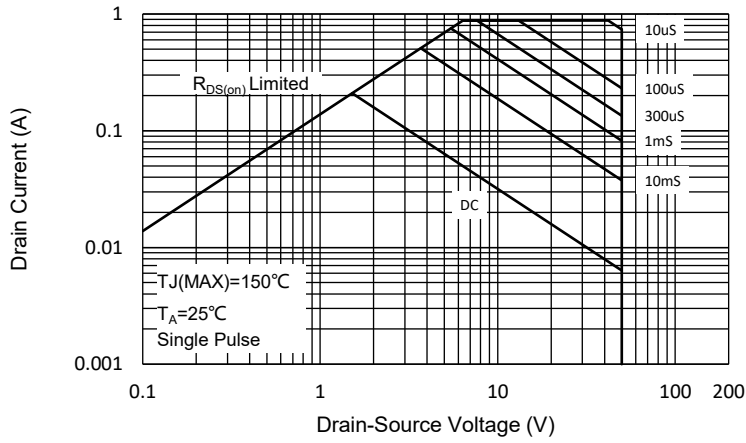
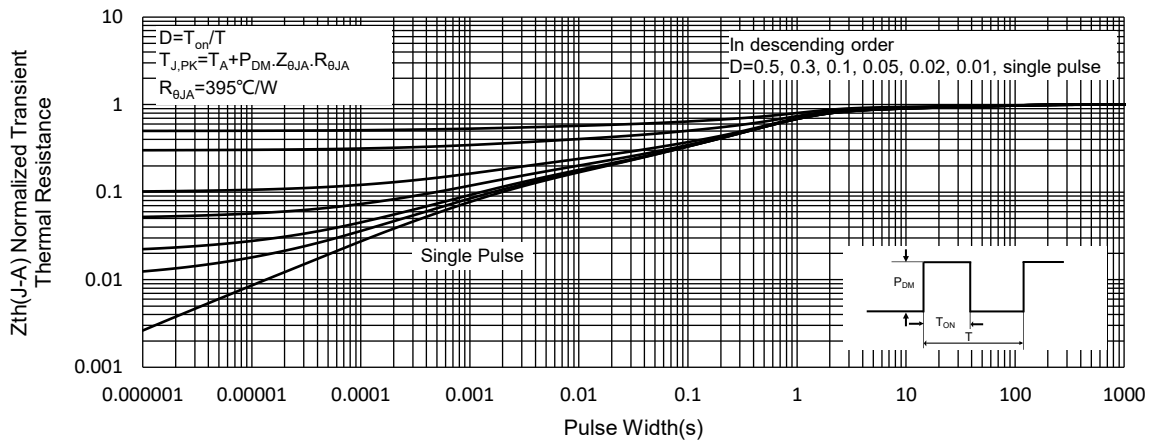


Fig.13 - Normalized Transient Thermal Impedance



Ordering Information

Device	Packing
Part Number-TP	Tape&Reel:3Kpcs/Reel

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